

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

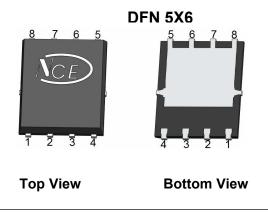
Application

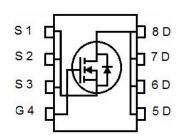
- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =72V, I_D =120A $R_{DS(ON)}$ =2.4m Ω , typical @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!





Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P035N72GU	NCEP035N72GU	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	72	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	120	A
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	92	Α
Pulsed Drain Current	I _{DM}	480	Α
Maximum Power Dissipation	P _D	90	W
Derating factor		0.72	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	870	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2) R _{θJC} 1.39 °C/W

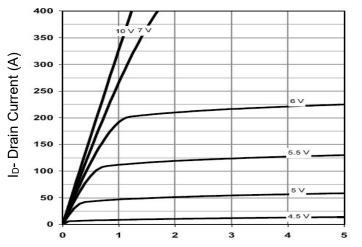
Electrical Characteristics (T_C=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	72		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =72V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•	•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =60A	-	2.4	3.5	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =60A	75	-	-	S
Dynamic Characteristics (Note4)			'	•		
Input Capacitance	C _{lss}	V _{DS} =35V,V _{GS} =0V,	-	4250	-	PF
Output Capacitance	Coss		-	670	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	28	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS
Turn-on Rise Time	t _r	V_{DD} =35 V , I_D =60 A	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	35	-	nS
Turn-Off Fall Time	t _f		-	8	-	nS
Total Gate Charge	Qg	V _{DS} =35V,I _D =60A,	-	67.5	-	nC
Gate-Source Charge	Q _{gs}		-	18.8		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	13.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =60A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	120	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 60A	-	68	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	98	-	nC

Notes:

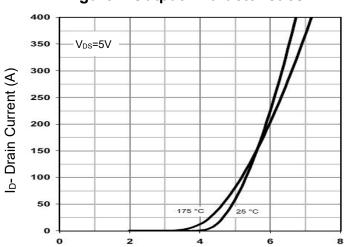
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V_DD=35V,V_G=10V,L=0.5mH,Rg=25 Ω

Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

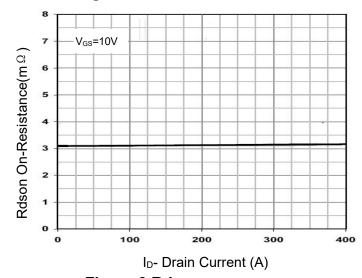
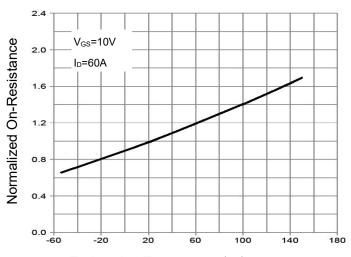


Figure 3 Rdson- Drain Current



T_J-Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature

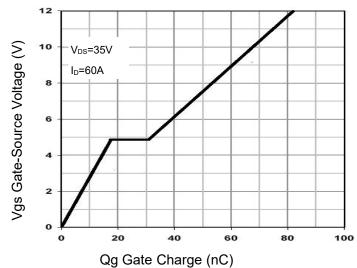
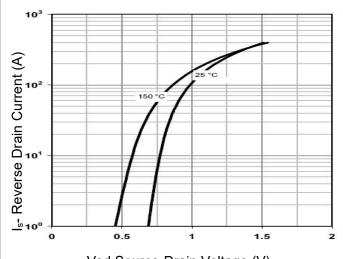


Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

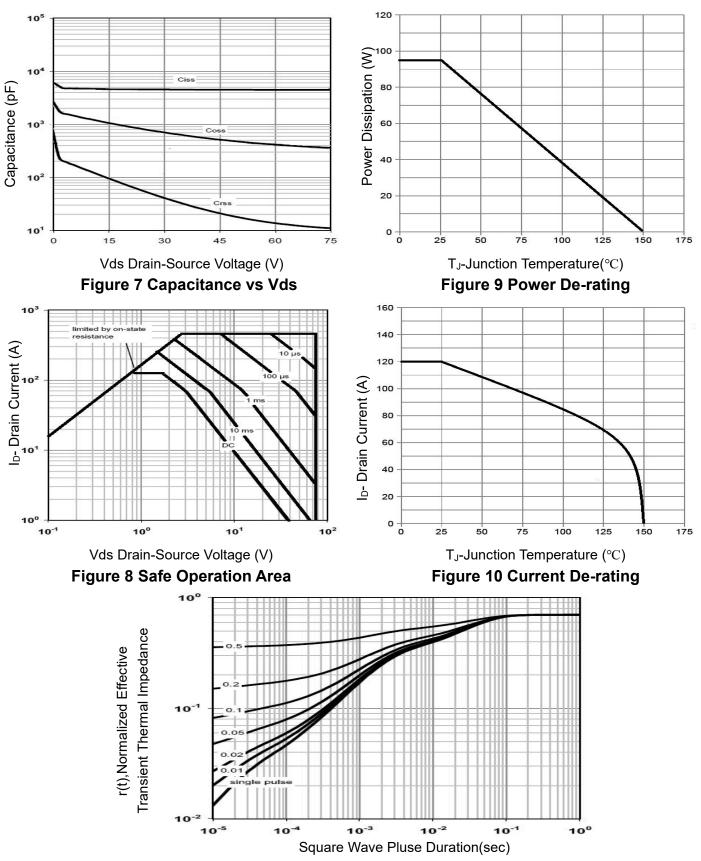
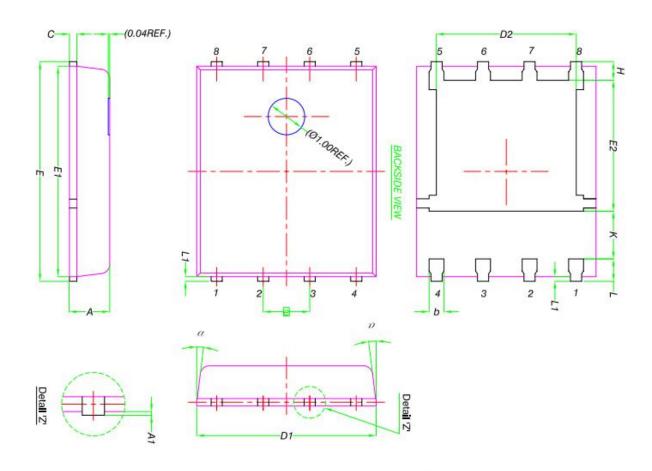
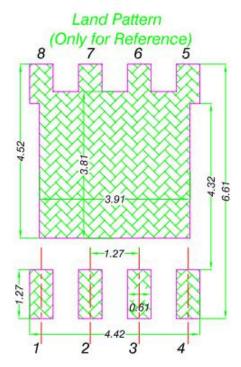


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



	N	ERS	
DIM.	MIN.	NOM.	MAX.
Α	0.90	1.00	1.10
A1	0	-	0.05
b	0.33	0.41	0.51
С	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
Ε	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
е	- 6	1.27 BSC	
Н	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
α	0°		12



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